

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

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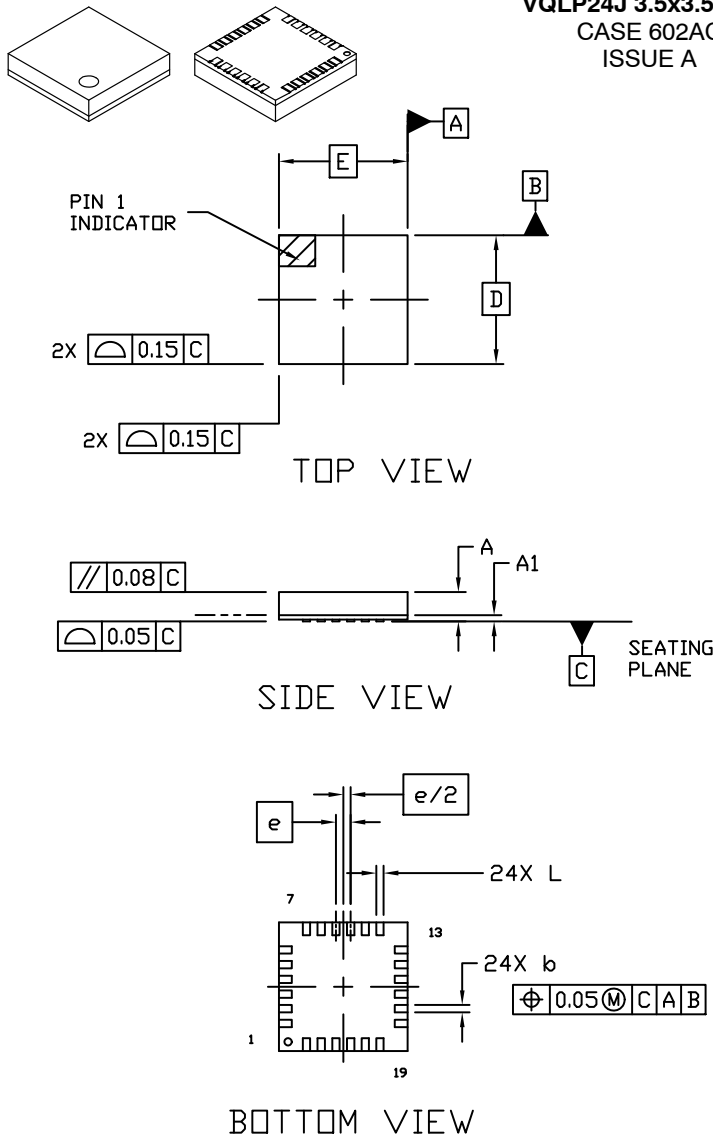


VQLP24J 3.5x3.5, 0.4P

CASE 602AC

ISSUE A

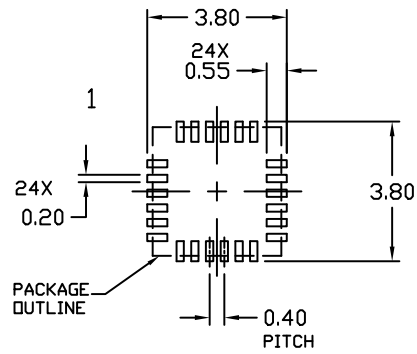
DATE 29 JAN 2014



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS

DIM	MILLIMETERS	
	MIN.	MAX.
A	---	0.85
A1	---	0.05
b	0.15	0.25
D	3.50 BSC	
E	3.50 BSC	
e	0.40 BSC	
L	0.30	0.40



GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code
Y = Year
M = Month
DDD = Additional Traceability Data

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Y = Year
DD = Additional Traceability Data

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

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